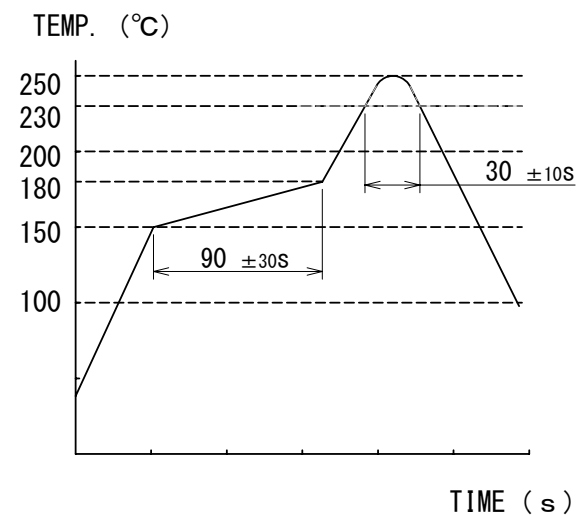
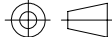




1. RECOMMENDED REFLOW PROFILE (SEE RIGHT GRAPH)  
CYCLE TIME: UP TO 2 CYCLES OF REFLOW SOLDERING ARE POSSIBLE UNDER THE CONDITIONS, PROVIDED THAT THERE IS A RETURN TO NOMAL TEMPERATURE BETWEEN THE FIRST AND SECOND CYCLE.  
PEAK TEMPERATURE: 250°C  
230°C MIN, FOR 20 TO 40 SECONDS.  
PREHEATING AREA 150~180°C FOR 60 TO 120 SECONDS.
2. HAND SOLDERING: 280~300°C, 2SECONDS MAX.
3. CONTACT COPLANARITY: 0.1mm MAX.
4. RECOMMENDED THICKNESS OF PCB: 1.6mm
5. RECOMMENDED THICKNESS OF SOLDERING PASTE: 0.12mm



3	BRASS	TIN PLATING								
2	PA	GREEN	5	POLYIMIDE	PICK & PLACE TAPE					
1	COPPER ALLOY	TIN PLATING		4	BRASS	TIN PLATING				
NO.	MATERIAL	FINISH , REMARKS		NO.	MATERIAL	FINISH , REMARKS				
<div>UNITS mm</div> <div></div>	<div>SCALE 2 : 1</div> <div></div> <div>0</div>	<div>DESCRIPTION OF REVISIONS</div> <div>DIS-T-00018485</div>			<div>DESIGNED</div> <div>KN. YANAGIMOTO</div>		<div>CHECKED</div> <div>EJ. WAKATSUKI</div>		<div>DATE</div> <div>2023. 10. 15</div>	
<div>HRS</div> <div>HIROSE ELECTRIC CO., LTD.</div>	APPROVED : AR. SHIRAI		2018. 02. 01		<div>DRAWING NO.</div> <div>EDC-362124-30-01</div>					
	CHECKED : AR. SHIRAI		2018. 02. 01		<div>PART NO.</div> <div>GT32-4DP-1. 5V (B) (30)</div>					
	DESIGNED : TS. KUBOTA		2018. 02. 01		<div>CODE NO</div> <div>CL0782-0066-7-30</div>					
	DRAWN : TS. KUBOTA		2018. 02. 01		<div></div> <div>1</div>					